Document Number: IMGV0001-15 Production Datasheet V1.0

# DC-150MHz, 15W, 36V LDMOS Fully matched PA Module

#### **Description**

The IMGV0001-15 is a 15-watt ,single stage integrated Power Amplifier Module, designed for broad band applications, with frequencies from DC to 150MHz. The module is 50  $\Omega$  input/output matched and requires minimal external components.



The module is used to the driver for RF Generator or ISM application running at HF/VHF, with one unique design to cover all typical frequencies like 13.56/27.12/40.68/60/64/88-108/128MHz etc

#### V<sub>DS</sub>= 36V, I<sub>DQ</sub>=225 mA Vqs =3.75V

Parameter	13.56MHz	27.12MHz	40.68MHz	60MHz	128MHz	150MHz	Units
Linear Gain	19.1	19.5	19.9	20.7	20.0	19.6	dB
Gain@Pin=26dBm	15. 7	15.6	15. 7	15.8	15.6	15.6	dB
Pout@Pin=26dBm	14.9	14.6	14.6	15.0	14.5	14.4	W
Eff@Pin=26dBm	73	75	76	77	70	67	%

### V<sub>DS</sub>= 40V, I<sub>DQ</sub>=225 mA

#### Vgs =3.75V

	Parameter	13.56MHz	27.12MHz	40.68MHz	60MHz	128MHz	150MHz	Units
	Linear Gain	19.2	19.6	19.9	20.8	20.2	19.8	dB
	Gain@Pin=27dBm	15.6	15.5	15. 5	15.6	15.5	15.5	dB
Ī	Pout@Pin=27dBm	18.4	18.0	18. 1	18. 5	17.8	17.7	W
Ī	Eff@Pin=27dBm	73	75	76	77	70	67	%

#### **Product Features**

Operating Frequency Range: DC-150MHz
Operating Drain Voltage: +36 V up to 40V

50 Ω Input/OutputPsat: ≥15W

• Small signal gain:>19dB, Power gain:>14dB

• Minimum efficiency:>70%

• 6x10 mm Surface Mount Package

• Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

• Much lower cost than GaN-based ultrawide band PA, due to LDMOS technology used

#### **Applications**

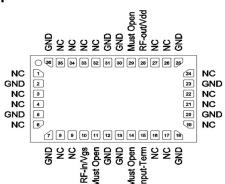
- •RF Generotor
- •HF Communication
- •FM radio



# Innogration (Suzhou) Co., Ltd.

Document Number: IMGV0001-15 Production Datasheet V1.0

### **Pin Configuration and Description**



Top View

Pin No.	Symbol	Description		
28 RFout/Vdd		Transistor 1, Drain Bias & RF Output		
10	RFin/Vgs	Transistor 1, RF Input &Gate Bias		
15	Input-Term	Transistor 1, Input 50 ohm term		
Others	NC	No connection		
11, 14, 29	Must Open	Keep the pin open, no GND		
2,5,7,12,13,16,20,23,25, 30, 31,36 Package Base	GND	DC/RF Ground. Must be soldered to EVB ground plane over array of vias for thermal and RF performance. Solder voids under Pkg Base will result in excessive junction temperatures causing permanent damage.		

#### **Table 1. Maximum Ratings**

Rating	Symbol	Value	Unit
DrainSource Voltage	V <sub>DSS</sub>	115	Vdc
GateSource Voltage	V <sub>GS</sub>	-10 to +10	Vdc
Operating Voltage	V <sub>DD</sub>	+42	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	Τ <sub>J</sub>	+200	°C

#### **Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Rejc	1.7	0C/M/
T <sub>C</sub> = 25°C, DC test	Keac	1.7	°C/W

#### **Table 3. Electrical Characteristics**

Parameter	Condition	Min	Тур	Max	Unit
Frequency Range	Pin=26dBm	1		150	MHz
Power Gain @ Psat	Pin=26dBm	14			dB
P <sub>SAT</sub>	Pin=26dBm		42		dBm
Drain Efficiency @ P <sub>SAT</sub> Pin=26dBm 70 %					
Unless otherwise noted: TA = 25°C, V <sub>DD</sub> =36 V, Pulse Width=100 us, Duty cycle=10%					

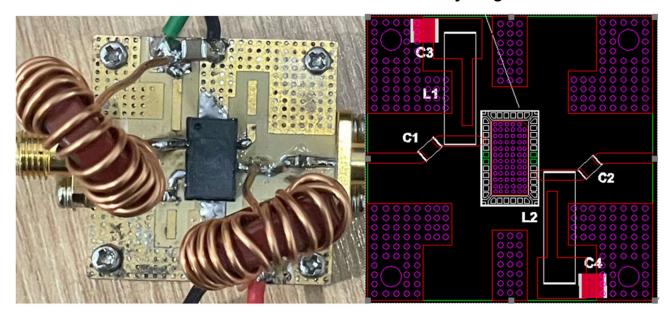
Load Mismatch of per Section (On Test Fixture, 50 ohm system): V<sub>DD</sub> =36 V, I<sub>DQ</sub> =225 mA, f = 150MHz

VSWR 10:1 at Psat pulse CW Output Power	No Device Degradation
---	-----------------------

# Innogration (Suzhou) Co., Ltd.

Document Number: IMGV0001-15 Production Datasheet V1.0

# Reference Circuit of Test Fixture Assembly Diagram

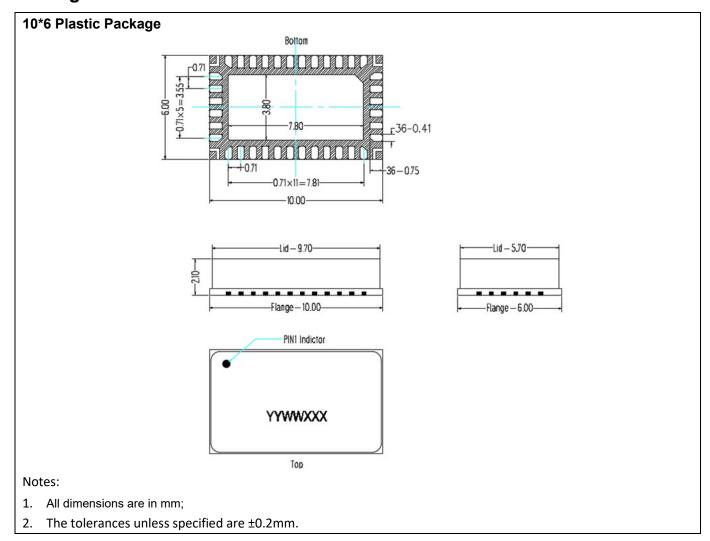


		Part NO.	Vendor
C3,C4	10uF 100V Chip Capacitor	C5750X7S2A106M230KB	TDK
C1,C2	50V 1uF Chip Capacitor	GRM21BR71H105KA12L	muRata
L1,L2	Inductor	T68-2 wire 1mm	
РСВ	RO4350B,20mil,er=3.48		

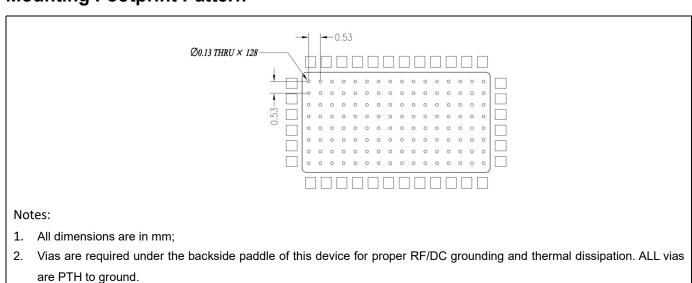
# Innogration (Suzhou) Co., Ltd.

Document Number: IMGV0001-15 Production Datasheet V1.0

## **Package Dimensions**



## **Mounting Footprint Pattern**



Document Number: IMGV0001-15 Production Datasheet V1.0

#### **Revision history**

#### Table 6. Document revision history

Date	Revision	Datasheet Status
2024/4/8	Rev 1.0	Production Datasheet

Application data based on ZHH-24-05

#### **Disclaimers**

Specifications are subject to change without notice. Innogration believes the information contained within this data sheet to be accurate and reliable. However, no responsibility is assumed by Innogration for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Innogration . Innogration makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose. "Typical" parameters are the average values expected by Innogration in large quantities and are provided for information purposes only. These values can and do vary in different applications and actual performance can vary over time. All operating parameters should be validated by customer's technical experts for each application. Innogration products are not designed, intended or authorized for use as components in applications intended for surgical implant into the body or to support or sustain life, in applications in which the failure of the Innogration product could result in personal injury or death or in applications for planning, construction, maintenance or direct operation of a nuclear facility. For any concerns or questions related to terms or conditions, pls check with Innogration and authorized distributors

Copyright © by Innogration (Suzhou) Co.,Ltd.